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Docket No.: 11948-17

FORM PTO-1595 (Modified)  
(Rev. 03-01)  
OMB No. 0651-0027 (exp. 5/31/2002)  
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To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
**Jon-hwan Kim; Gi-ho Cha; Mun-heui Choi; Chang-beom Jeong**

2. Name and address of receiving party(ies):

Name: **Fairchild Korea Semiconductor Ltd**

Address: **420-711**

**82-3 Dodang-Dong, Wonmi-Ku**

Additional names(s) of conveying party(ies)  Yes  No

3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other \_\_\_\_\_

City: **Bucheon City** State/Prov.: **Kyonggi-Do**

Country: **Korea** ZIP: \_\_\_\_\_

Execution Date: **March 2, 2005**

Additional name(s) & address(es)  Yes  No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is

Patent Application No.	Filing date	B. Patent No.(s)
10/441,527	May 19, 2003	

Additional numbers  Yes  No

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Kenneth E. Horton**

Registration No. **39,481**

Address: **Kirton & McConkie**

**P.O. Box 45120**

City: **Salt Lake City** State/Prov.: **UT**

Country: **USA** ZIP: **84145-0120**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

**Kenneth E. Horton**

**March 2, 2005**

Name of Person Signing

Signature

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**PATENT**  
**REEL: 016329 FRAME: 0178**

ASSIGNMENT

For valuable consideration, the receipt and adequacy of which is hereby acknowledged, and in fulfillment of our pre-existing obligation of assignment, we, Jong-hwan Kim, Gi-ho Cha, Mun-heul Choi and Chang-beom Jeong sell and assign to Fairchild Korea Semiconductor Ltd., a Corporation of the Republic of Korea, its successors and assigns the entire right, title and interest in and to the improvements "METHODS FOR MANUFACTURING SOI SUBSTRATE USING WAFER BONDING AND COMPLEMENTARY HIGH VOLTAGE BIPOLAR TRANSISTOR USING THE SOI SUBSTRATE" (Docket No. 11948.17) invented by us, as described in the application for United States patent filed on May 19, 2003, serial number 10/441,527, and any and all applications for patent and patents therefore in any and all countries, including all divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said United States application, and authorize and request any official whose duty it is to issue patents, to issue any patent on said improvements or resulting therefrom to said Fairchild Korea Semiconductor, Ltd., or its successors or assigns and agree that on request and without further consideration, but at the expense of said Corporation, we will communicate to said Corporation or its representatives or nominees any facts known to us respecting said improvements and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Corporation, its successors, assigns, and nominees to obtain and enforce proper patent protection for said improvements in all countries.

The aforementioned Assignors, Jong-hwan Kim, Gi-ho Cha, Mun-heul Choi and Chang-beom Jeong hereby declare that all statements made herein of our own knowledge are true and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Signed at town of \_\_\_\_\_, this 2 day of March, 2005.

Witnessed by \_\_\_\_\_  
Witness Signature & Date

Jong-hwan Kim  
Jong-hwan Kim

Printed Name of Witness

Signed at town of \_\_\_\_\_, this 2 day of March, 2005.

Witnessed by \_\_\_\_\_  
Witness Signature & Date

Gi-ho Cha  
Gi-ho Cha

Printed Name of Witness

Signed at town of \_\_\_\_\_ this 2 day of March, 2005

Witnessed by

Witness Signature & Date

  
Mun-heul Chol

Printed Name of Witness

Signed at town of \_\_\_\_\_ this 2 day of March, 2005

Witnessed by

Witness Signature & Date

  
Chang-beom Jeong

Printed Name of Witness

888878 v1 - Assignment